ASEDCIATION CONNECTING ELECTRONICS INDUSTRIES® Material Comp © Copyright 2005. 1 international and Par	PC. Bannockł	ourn. Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarati the declaration e	on of the su	bstances v s all lower	vithin the manufactu level materials for v	urer listed which the	item. Note: if nanufacturer	the item is an as has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Material					rials and M	ls and Mfg Information			
upplier Information														
Company name*			Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2024-05	2024-05-21			
Contact Name Title - Contact			et	J			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Env			nviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repr			resentative			Phone - Representative*			Email -	Email - Representative*				
Product-Env-Stewards Prod			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		ber Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
	FAN536	FAN53601AUC10X DC/DC 3MHz Buck		ick 1.0A		2024-05-21		PI	РВВ		1.897036	mg	Each	
Ianufacturing Proccess Informa	tion							Ĺ					-	
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base Al		Alloy	J-STD-020 MSI	Peak Process Body Temperature Max Time at Peak			k Tempera	Temperature Number of Reflow Cycles					
SnAgCu CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperatu	ire during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or e [F] Optionally enter the positive (+)				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.16284	mg	Supplier	Silicon (Si)	7440-21-3		1.1603	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0025	mg
Solder Ball	0.730196	mg	Supplier	Silver (Ag)	7440-22-4		0.0292	mg
			Supplier	Tin (Sn)	7440-31-5		0.6973	mg
			Supplier	Copper (Cu)	7440-50-8		0.0037	mg
Under Bump Metal	0.004	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			В	Nickel (Ni)	7440-02-0		0.003	mg
			Supplier	Gold (Au)	7440-57-5		0.001	mg
			Supplier	Copper (Cu)	7440-50-8		0	mg